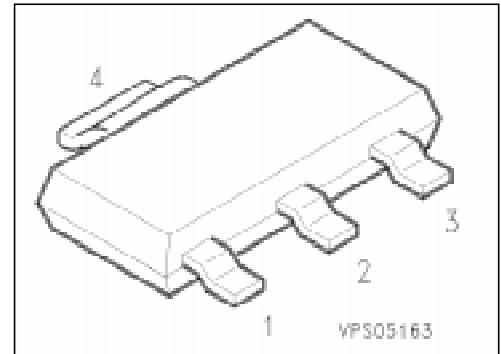


## NPN Silicon AF Transistors

**BCP 54**  
... **BCP 56**

- For AF driver and output stages
- High collector current
- Low collector-emitter saturation voltage
- Complementary types: BCP 51 ... BCP 53 (PNP)



Type	Marking	Ordering Code (tape and reel)	Pin Configuration				Package <sup>1)</sup>
			1	2	3	4	
BCP 54	BCP 54	Q62702-C2117	B	C	E	C	SOT-223
BCP 54-10	BCP 54-10	Q62702-C2119					
BCP 54-16	BCP 54-16	Q62702-C2120					
BCP 55	BCP 55	Q62702-C2148					
BCP 55-10	BCP 55-10	Q62702-C2122					
BCP 55-16	BCP 55-16	Q62702-C2123					
BCP 56	BCP 56	Q62702-C2149					
BCP 56-10	BCP 56-10	Q62702-C2125					
BCP 56-16	BCP 56-16	Q62702-C2106					

<sup>1)</sup> For detailed information see chapter Package Outlines.

## Maximum Ratings

Parameter	Symbol	Values			Unit
		BCP 54	BCP 55	BCP 56	
Collector-emitter voltage $R_{BE} \leq 1 \text{ k}\Omega$	$V_{CE0}$	45	60	80	V
	$V_{CER}$	45	60	100	
Collector-base voltage	$V_{CB0}$	45	60	100	
Emitter-base voltage	$V_{EB0}$	5			
Collector current	$I_C$	1			A
Peak collector current	$I_{CM}$	1.5			
Base current	$I_B$	100			mA
Peak base current	$I_{BM}$	200			
Total power dissipation, $T_S = 124 \text{ }^\circ\text{C}^{1)}$	$P_{tot}$	1.5			W
Junction temperature	$T_j$	150			$^\circ\text{C}$
Storage temperature range	$T_{stg}$	- 65 ... + 150			

## Thermal Resistance

Junction - ambient <sup>1)</sup>	$R_{th \text{ JA}}$	$\leq 72$	K/W
Junction - soldering point	$R_{th \text{ JS}}$	$\leq 17$	

<sup>1)</sup> Package mounted on epoxy pcb 40 mm × 40 mm × 1.5 mm/6 cm<sup>2</sup> Cu.

## Electrical Characteristics

at  $T_A = 25\text{ °C}$ , unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

### DC characteristics

Collector-emitter breakdown voltage $I_C = 10\text{ mA}$ , $I_B = 0$	$V_{(BR)CE0}$	45 60 80	– – –	– – –	V
BCP 54					
BCP 55					
Collector-base breakdown voltage <sup>1)</sup> $I_C = 100\text{ }\mu\text{A}$ , $I_B = 0$	$V_{(BR)CB0}$	45 60 100	– – –	– – –	
BCP 54					
BCP 55					
BCP 56					
Emitter-base breakdown voltage $I_E = 10\text{ }\mu\text{A}$ , $I_C = 0$	$V_{(BR)EB0}$	5	–	–	
Collector-base cutoff current $V_{CB} = 30\text{ V}$ , $I_E = 0$ $V_{CB} = 30\text{ V}$ , $I_E = 0$ , $T_A = 150\text{ °C}$	$I_{CB0}$	– –	– –	100 20	nA $\mu\text{A}$
Emitter-base cutoff current $V_{EB} = 5\text{ V}$	$I_{EB0}$	–	–	10	$\mu\text{A}$
DC current gain $I_C = 5\text{ mA}$ , $V_{CE} = 2\text{ V}$ $I_C = 150\text{ mA}$ , $V_{CE} = 2\text{ V}$	$h_{FE}$	25	–	–	–
BCP 54/BCP 55/BCP 56		40	–	250	
BCP 54/BCP 55/BCP 56-10		63	100	160	
BCP 54/BCP 55/BCP 56-16		100	160	250	
$I_C = 500\text{ mA}$ , $V_{CE} = 2\text{ V}$		25	–	–	
Collector-emitter saturation voltage <sup>1)</sup> $I_C = 500\text{ mA}$ , $I_B = 50\text{ mA}$	$V_{CEsat}$	–	–	0.5	V
Base-emitter voltage <sup>1)</sup> $I_C = 500\text{ mA}$ , $V_{CE} = 2\text{ V}$	$V_{BE}$	–	–	1	

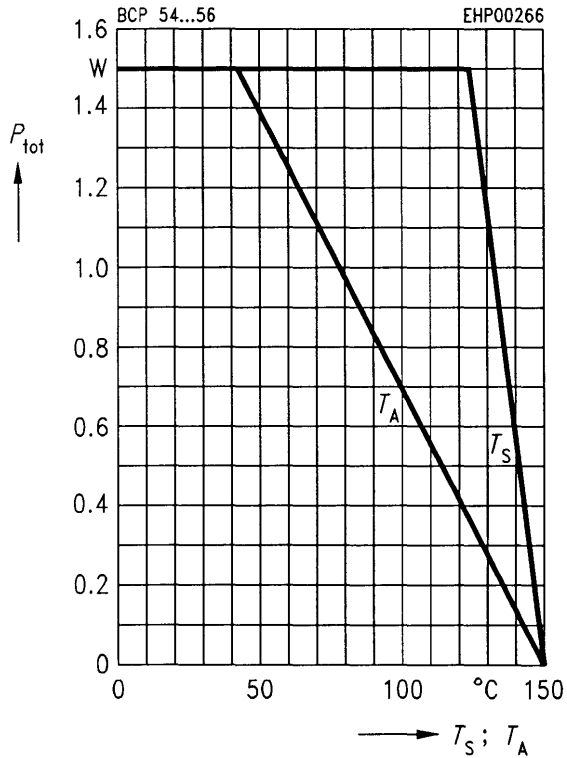
### AC characteristics

Transition frequency $I_C = 50\text{ mA}$ , $V_{CE} = 10\text{ V}$ , $f = 100\text{ MHz}$	$f_T$	–	100	–	MHz
--	-------	---	-----	---	-----

<sup>1)</sup> Pulse test conditions:  $t \leq 300\text{ }\mu\text{s}$ ,  $D = 2\text{ %}$ .

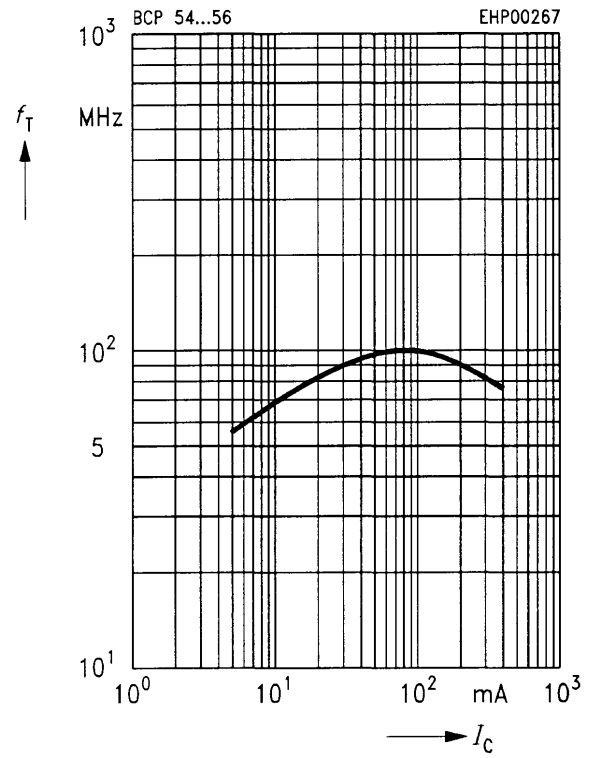
### Total power dissipation $P_{tot} = f(T_A^*; T_S)$

\* Package mounted on epoxy



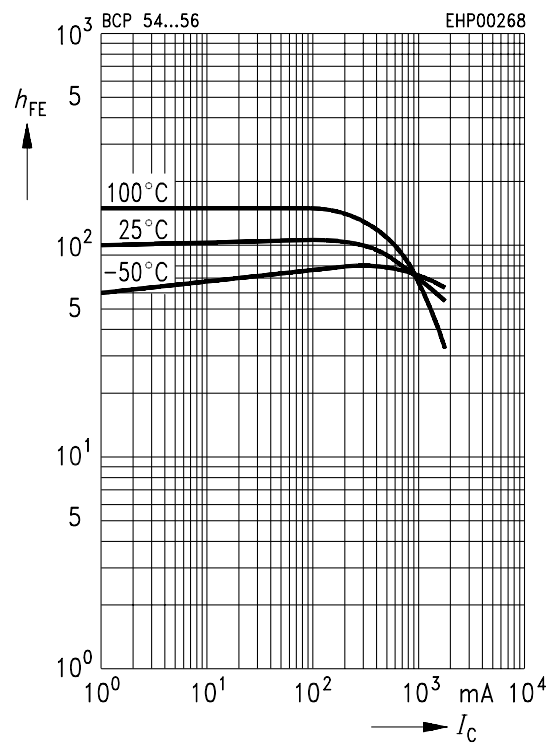
### Transition frequency $f_T = f(I_C)$

$V_{CE} = 10\text{ V}$



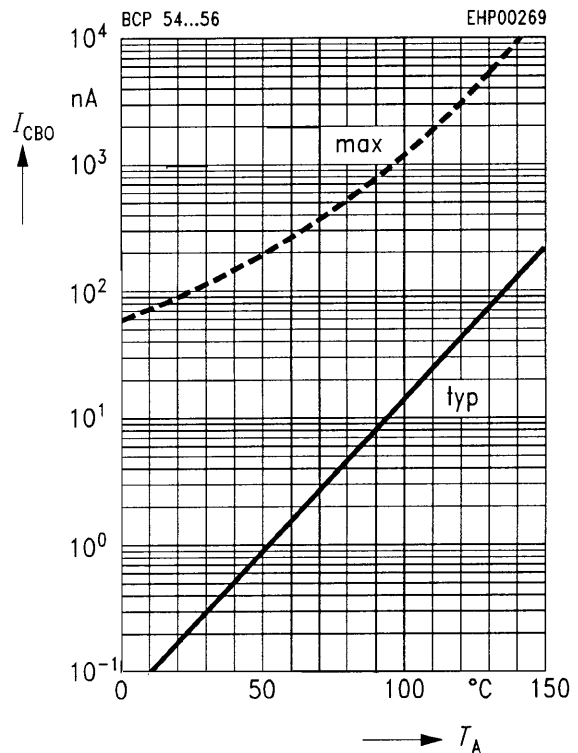
### DC current gain $h_{FE} = f(I_C)$

$V_{CE} = 2\text{ V}$



### Collector cutoff current $I_{CBO} = f(T_A)$

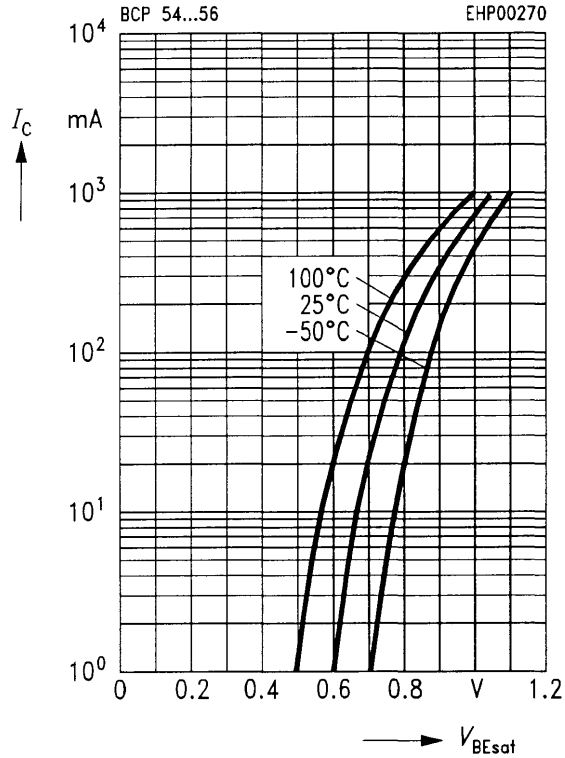
$V_{CB} = 30\text{ V}$



**Base-emitter saturation voltage**

$I_C = f(V_{BEsat})$

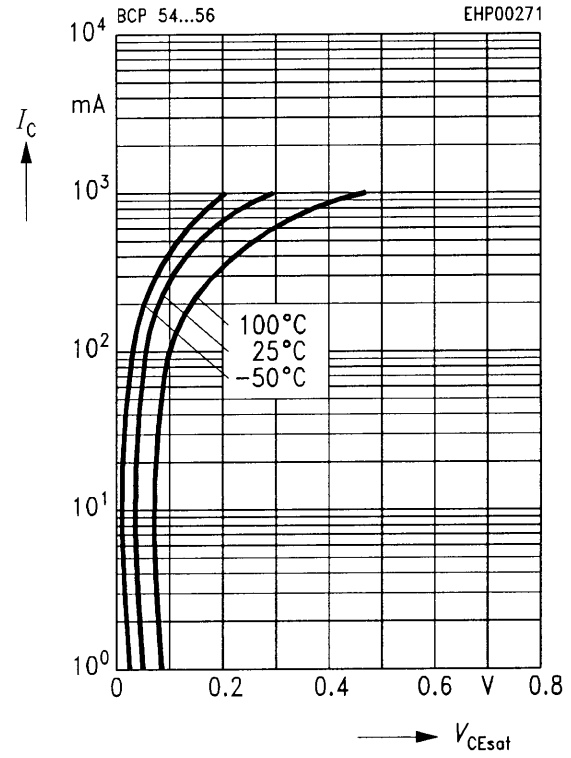
$h_{FE} = 10$



**Collector-emitter saturation voltage**

$I_C = f(V_{CEsat})$

$h_{FE} = 10$



**Permissible pulse load  $P_{tot max}/P_{tot DC} = f(t_p)$**

